

12 A Three-quadrant triacs high commutation insulatedRev. 01 — 27 September 2007Product data

Product data sheet

1. **Product profile**

1.1 General description

Passivated, new generation, high commutation triacs in an internally insulated TO-220 plastic package

1.2 Features

	Very high commutation performanceIsolated mounting base	High immunity to dV/dt2500 V RMS isolation voltage
1.3	Applications	
	Motor control - e.g. washing machinesRefrigeration compressors	Non-linear rectifier-fed motor loadsLamp dimmers for US market
1.4	Quick reference data	
	■ $V_{DRM} \le 600 \text{ V} (BTA312Y-600C)$ ■ $V_{DRM} \le 800 \text{ V} (BTA312Y-800C)$ ■ $I_{GT} \le 35 \text{ mA}$	■ $I_{T(RMS)} \le 12 \text{ A}$ ■ $I_{TSM} \le 100 \text{ A} (t = 20 \text{ ms})$ ■ $I_{TSM} \le 110 \text{ A} (t = 16.7 \text{ ms})$

2. Pinning information

Table 1.	Pinning		
Pin	Description	Simplified outline	Symbol
1	main terminal 1 (T1)		N 1
2	main terminal 2 (T2)	mb	T2-T1
3	gate (G)	r 🔾 h	sym051
mb	mounting base; isolated		

SOT78D (TO-220)



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3. Ordering information

Table 2. Ordering information					
Type number	Package				
	Name	Description	Version		
BTA312Y-600C		plastic single-ended package; isolated heatsink mounted; 1 mounting hole;	SOT78D		
BTA312Y-800C		3-lead TO-220			

4. Limiting values

Table 3. Limiting values

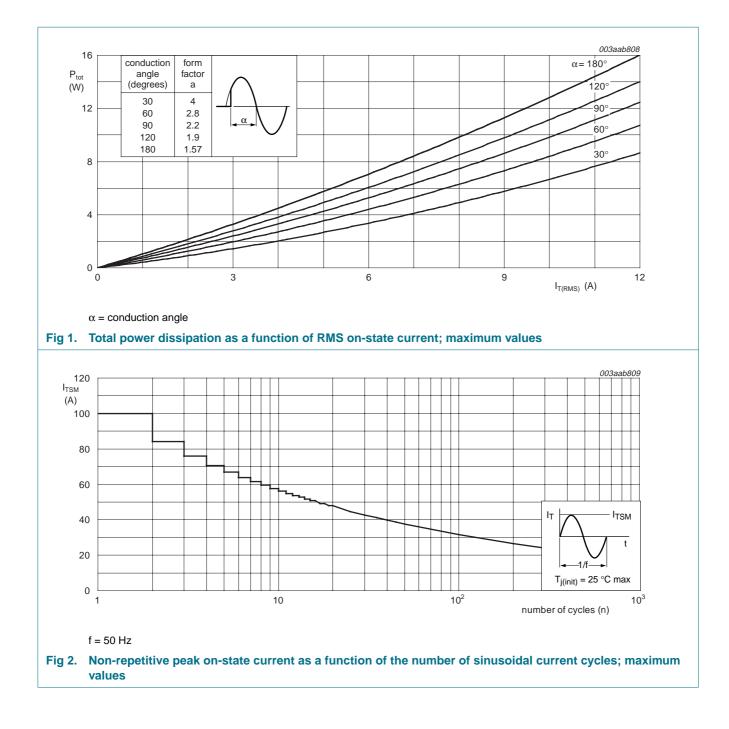
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DRM}	repetitive peak off-state voltage	BTA312Y-600C;	<u>[1]</u> _	600	V
		BTA312Y-800C;	-	800	V
I _{T(RMS)}	RMS on-state current	full sine wave; $T_{mb} \le 85 \text{ °C}$; see Figure 4 and 5	-	12	А
I _{TSM}	non-repetitive peak on-state current	full sine wave; $T_j = 25 \text{ °C prior to}$ surge; see Figure 2 and 3			
		t = 20 ms	-	100	А
		t = 16.7 ms	-	110	А
l ² t	l ² t for fusing	t = 10 ms	-	50	A ² s
dl _T /dt	rate of rise of on-state current	$I_{TM} = 20 \text{ A}; I_G = 0.2 \text{ A};$ $dI_G/dt = 0.2 \text{ A}/\mu \text{s}$	-	100	A/µs
I _{GM}	peak gate current		-	2	А
P _{GM}	peak gate power		-	5	W
P _{G(AV)}	average gate power	over any 20 ms period	-	0.5	W
T _{stg}	storage temperature		-40	+150	°C
Tj	junction temperature		-	125	°C

[1] Although not recommended, off-state voltages up to 800 V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 15 A/μs.

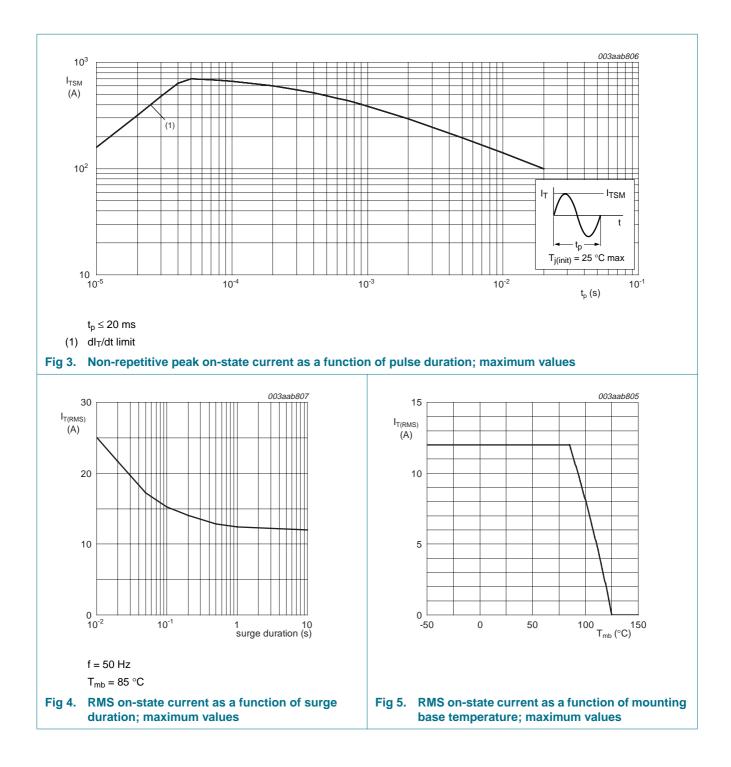
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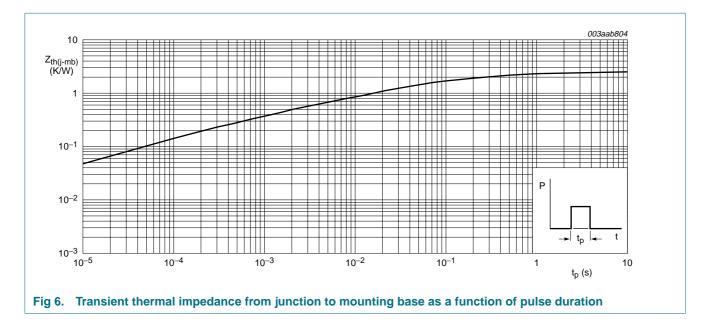
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5. Thermal characteristics

Table 4.	Inermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	full cycle; see Figure 6	-	-	2.3	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	-	60	-	K/W



6. Isolation characteristics

Table 5. Isolation limiting values and characteristics

 $T_h = 25 \circ C$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{isol(RMS)}	RMS isolation voltage	from all three terminals to external heatsink; f = 50 Hz to 60 Hz; sinusoidal waveform; RH \leq 65 %; clean and dust free	-	-	2500	V
C _{isol}	isolation capacitance	from pin 2 to external heatsink; f = 1 MHz	-	10	-	pF

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7. Static characteristics

Table 6. Static characteristics

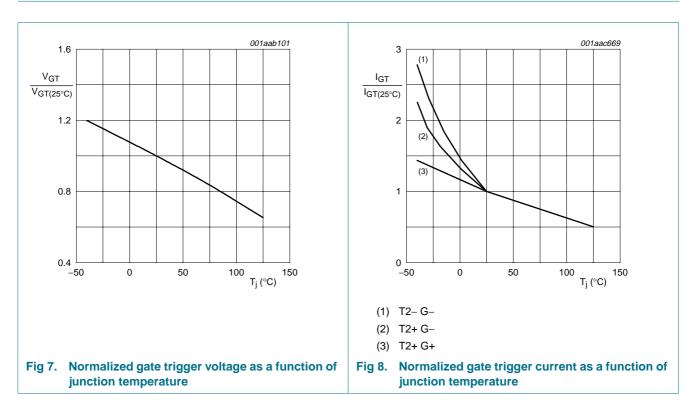
 $T_i = 25 \circ C$ unless otherwise specified.

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit			
I _{GT} gate trigger current		$V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ see } \frac{\text{Figure 8}}{100000000000000000000000000000000000$	$V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ see } Figure 8$						
		T2+ G+	2	-	35	mA			
		T2+ G–	2	-	35	mΑ			
		T2– G–	2	-	35	mA			
۱L	latching current	$V_D = 12 \text{ V}; \text{ I}_{GT} = 0.1 \text{ A}; \text{ see } \frac{\text{Figure } 10}{10}$							
		T2+ G+	-	-	50	mA			
		T2+ G–	-	-	60	mA			
		T2– G–	-	-	50	mA			
I _H	holding current	$V_D = 12 \text{ V}; \text{ I}_{GT} = 0.1 \text{ A}; \text{ see } \frac{\text{Figure } 11}{100000000000000000000000000000000$	-	-	35	mA			
VT	on-state voltage	I _T = 15 A; see <u>Figure 9</u>	-	1.3	1.6	V			
V _{GT}	gate trigger voltage	$V_D = 12 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ see } \frac{\text{Figure 7}}{100000000000000000000000000000000000$	-	0.8	1.5	V			
		$V_D = 400 \text{ V}; \text{ I}_T = 0.1 \text{ A}; \text{ T}_j = 125 \ ^\circ\text{C}$	0.25	0.4	-	V			
I _D	off-state current	$V_D = V_{DRM(max)}; T_j = 125 \ ^{\circ}C$	-	0.1	0.5	mA			

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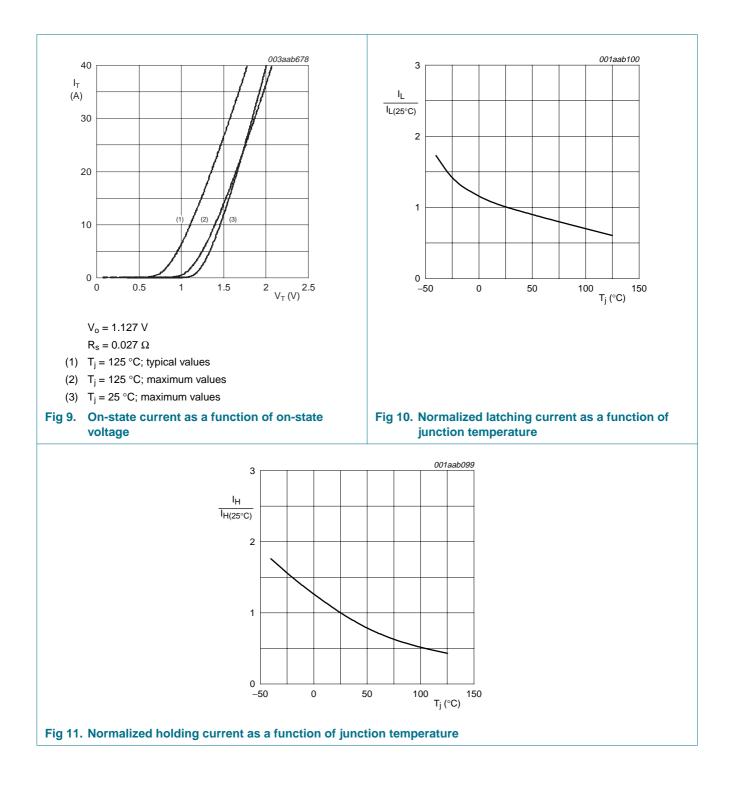
8. Dynamic characteristics

Table 7.	Dynamic chara	cteristics				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 0.67 \times $V_{DRM(max)};$ T_{j} = 125 °C; exponential waveform; gate open circuit	500	-	-	V/µs
dl _{com} /dt	rate of change of commutating current	V_{DM} = 400 V; T_{j} = 125 °C; $I_{T(RMS)}$ = 12 A; without snubber; gate open circuit	20	-	-	A/ms
t _{gt}	gate-controlled turn-on time	$I_{TM} = 20 \text{ A}; V_D = V_{DRM(max)}; I_G = 0.1 \text{ A}; dI_G/dt = 5 A/\mu s$	-	2	-	μs



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9. Package outline

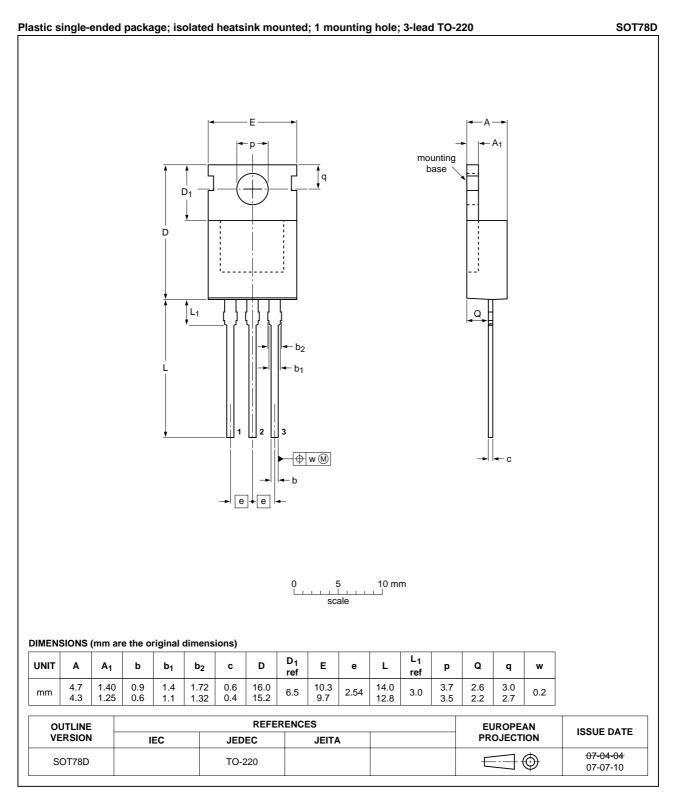


Fig 12. Package outline SOT78D (3-lead TO-220)

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10. Revision history

Table 8. Revision hist	8. Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes		
BTA312Y_SER_C_1	20070927	Product data sheet	-	-		

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11. Legal information

11.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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